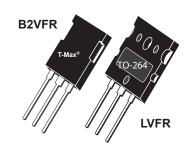


APT20M18B2VFR A20M18LVFR

200V 100A 0.018Ω

POWER MOS V® FREDFET

Power MOS V^{\otimes} is a new generation of high voltage N-Channel enhancement mode power MOSFETs. This new technology minimizes the JFET effect, increases packing density and reduces the on-resistance. Power MOS V^{\otimes} also achieves faster switching speeds through optimized gate layout.



- T-MAX™ or TO-264 Package
- Avalanche Energy Rated

Faster Switching

FAST RECOVERY BODY DIODE

Lower Leakage



MAXIMUM RATINGS

All Ratings: T_C = 25°C unless otherwise specified.

Symbol	Parameter	APT20M18B2VFR_LVFR	UNIT	
V _{DSS}	Drain-Source Voltage	200	Volts	
I _D	Continuous Drain Current ⁶ @ T _C = 25°C	100	Amps	
I _{DM}	Pulsed Drain Current ①	400	7 till po	
V _{GS}	Gate-Source Voltage Continuous	±30	Volts	
V _{GSM}	Gate-Source Voltage Transient	±40		
P _D	Total Power Dissipation @ T _C = 25°C	625	Watts	
' D	Linear Derating Factor	5.00	W/°C	
T_J , T_{STG}	Operating and Storage Junction Temperature Range	-55 to 150	°C	
T_L	Lead Temperature: 0.063" from Case for 10 Sec.	300		
I _{AR}	Avalanche Current (1) (Repetitive and Non-Repetitive)	100	Amps	
E _{AR}	Repetitive Avalanche Energy ①	50	mJ	
E _{AS}	Single Pulse Avalanche Energy ⁽⁴⁾	3000		

STATIC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
BV _{DSS}	Drain-Source Breakdown Voltage ($V_{GS} = 0V$, $I_D = 250\mu A$)	200			Volts
R _{DS(on)}	Drain-Source On-State Resistance $^{\textcircled{2}}$ ($V_{GS} = 15V$, $I_{D} = 50A$)			0.018	Ohms
I _{DSS}	Zero Gate Voltage Drain Current ($V_{DS} = 200V, V_{GS} = 0V$)			250	μΑ
	Zero Gate Voltage Drain Current (V_{DS} = 160V, V_{GS} = 0V, T_{C} = 125°C)			1000	
I _{GSS}	Gate-Source Leakage Current $(V_{GS} = \pm 30V, V_{DS} = 0V)$			±100	nA
V _{GS(th)}	Gate Threshold Voltage $(V_{DS} = V_{GS}, I_{D} = 2.5 \text{mA})$	2		4	Volts

CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

DYNAMIC CHARACTERISTICS

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
C _{iss}	Input Capacitance	V _{GS} = 0V		9880		
C _{oss}	Output Capacitance	V _{DS} = 25V		2320		pF
C _{rss}	Reverse Transfer Capacitance	f = 1 MHz		700		
Q _g	Total Gate Charge ^③	V _{GS} = 10V		330		
Q _{gs}	Gate-Source Charge	V _{DD} = 150V		55		nC
Q _{gd}	Gate-Drain ("Miller") Charge	I _D = 100A @ 25°C		145		
t _{d(on)}	Turn-on Delay Time	V _{GS} = 15V		18		
t _r	Rise Time	V _{DD} = 150V		27		ns
t _{d(off)}	Turn-off Delay Time	I _D = 100A @ 25°C		55		1.0
t _f	Fall Time	$R_{G} = 0.6\Omega$		6		

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

Symbol	Characteristic / Test Conditions		MIN	TYP	MAX	UNIT
I _s	Continuous Source Current (Body Diode)				100	Amps
I _{SM}	Pulsed Source Current (1) (Body Diode)				400	7 tilips
V _{SD}	Diode Forward Voltage ② (V _{GS} = 0V, I _S = -100A)				1.3	Volts
dv _/ dt	Peak Diode Recovery ^{dv} / _{df} ^⑤				8	V/ns
	Reverse Recovery Time	T _i = 25°C			230	ns
t _{rr}	$(I_S = -100A, \frac{di}{dt} = 100A/\mu s)$	T _i = 125°C			450	
	Reverse Recovery Charge	T _i = 25°C		0.9		μC
Q _{rr}	$(I_S = -100A, \frac{di}{dt} \le = 100A/\mu s)$	T _i = 125°C		3.4		
	Peak Recovery Current	T _i = 25°C		11		Amps
^I RRM	$(I_S = -100A, \frac{di}{dt} = 100A/\mu s)$	T _i = 125°C		20		

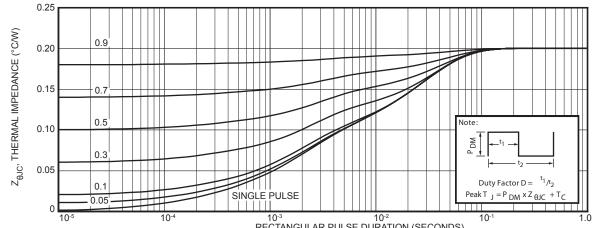
THERMAL CHARACTERISTICS

Symbol	Characteristic	MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to Case			0.20	°C/W
$R_{\theta JA}$	Junction to Ambient			40	

- ① Repetitive Rating: Pulse width limited by maximum junction temperature
- ② Pulse Test: Pulse width < 380 μs, Duty Cycle < 2%
- 3 See MIL-STD-750 Method 3471

- ④ Starting T_j = +25°C, L = 600μH, R_G = 25Ω, Peak I_L = 100A ⑤ ^{dv}/_{dt} numbers reflect the limitations of the test circuit rather than the device itself. $I_S \le -I_D 100A$ $I_d \le 200A/μs$ $I_R \le 200V$ $I_J \le 150°C$ 6 The maximum current is limited by lead temperature.

Microsemi reserves the right to change, without notice, the specifications and information contained herein.



RECTANGULAR PULSE DURATION (SECONDS)
FIGURE 1, MAXIMUM EFFECTIVE TRANSIENT THERMAL IMPEDANCE, JUNCTION-TO-CASE vs PULSE DURATION

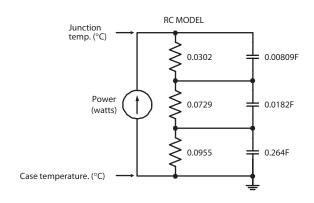
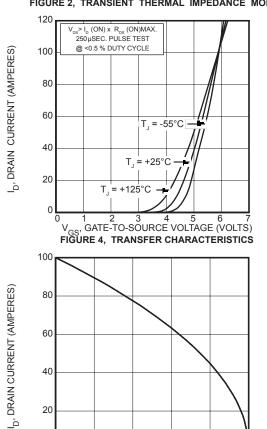
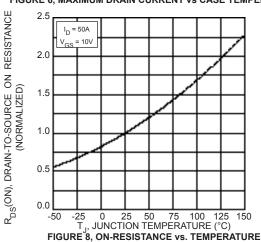


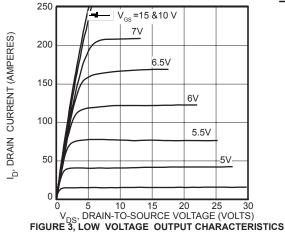
FIGURE 2, TRANSIENT THERMAL IMPEDANCE MODEL

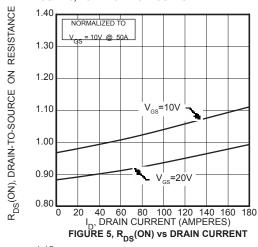


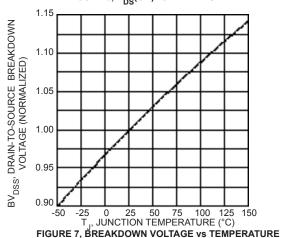
75 100 125 CASE TEMPERATURE (°C) FIGURE 6, MAXIMUM DRAIN CURRENT VS CASE TEMPERATURE

20





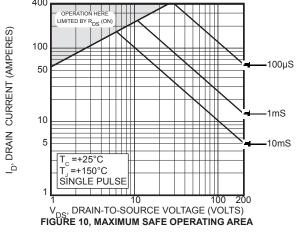


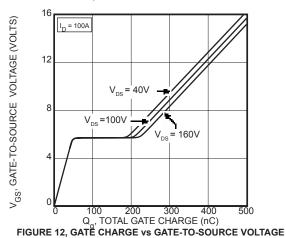


V_{GS}(TH), THRESHOLD VOLTAGE (NORMALIZED) 1.0 0.9 0.8 0.7 0.6

0 25 50 75 100 12 , CASE TEMPERATURE (°C) T_C, CASE TEMPERATURE (°C)
FIGURE 9, THRESHOLD VOLTAGE vs TEMPERATURE

Typical Performance Curves





APT20M18B2VFR_LVFR

30,000

10,000

C_{iss}

C_{oss}

1,000

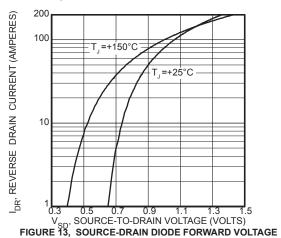
C_{ss}

C_{oss}

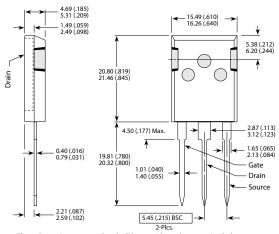
C_{oss}

Topic Drain-to-source voltage (volts)

FIGURE 11, CAPACITANCE vs DRAIN-to-SOURCE Voltage



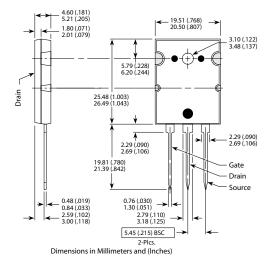
T-MAX[™] (B2) Package Outline (B2VFR)



These dimensions are equal to the TO-247 without the mounting hole.

Dimensions in Millimeters and (Inches)

TO-264 (L) Package Outline (LVFR)



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